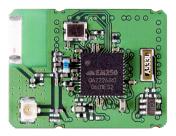
Cut the Cable

ZigBee[™]ready -Modem PAN4570



OUTLINES

The PAN4570 module is a short range, low power, 2,4GHz ISM band transceiver using the Ember™ EM250 single chip solution for ZigBee™, a IEEE802.15.4- compliant transceiver with a 16-bit XAP2b microprocessor.

With added onboard reference oscillators and optimized RF frontend circuitry PAN4570 provides the complete hardware needed for a ZigBee $^{\text{TM}}$ solution. PAN4570 comprises EmberZNet, the Ember $^{\text{TM}}$ ZigBee-compliant software stack, which is a ZigBee $^{\text{TM}}$ profile-ready platform compliant solution. A reliable Application Programming Interface based on the ZigBee $^{\text{TM}}$ specification is provided for the ease of the creation of application profiles.

Additional regulator and 32kHz crystal can be mounted in addition on cutomer demand.

FEATURES

- 3 antenna options: Plug, single port 50Ω or ceramic antenna
- 16 selectable Channels with 250 kbps in the 2.4 GHz band
- 3 different power modes for increased battery life
- High sensitivity of -98 dBm typ. at 1% Packet Error Rate
- +3dBm output power (+5dBm in boost mode)
- Low supply voltage (2.1 V to 3.6 V, 3.0 V typ.)
- Small size (20.0mm x 26.5mm x 3.0mm)
- onboard low power regulator
- Operating temperature range -40°C to +85°C
- 128k Flash and 5k SRAM memory
- Link quality and clear channel assessment capability
- All of the 17 GPIO of EM250 are available at the module pads, which are multiplexed to GPIO, UART, SPI, I2C or up to four analog inputs to an ADC and two timer waveform outputs
- Critical portions of IEEE802.15.4-2003 plus a first-line filter for non-intended packets are realized in hardware, thus reducing the workload on the μC

APPLICATIONS

- Remote control and wire replacement in industrial systems such as wireless sensor networks
- Factory / home automation and motor / lighting control
- Inventory management and RF ID tagging and AMR
- Monitoring (environmental, patient or fitness)

Panasonic Electronic Devices Europe GmbH

Design and Specifications are subject to change without notice. Ask the factory for technical specifications before purchase and/or use. If there is any doubt regarding the safety of this product, kindly inform us immediately for technical consultation.

4570-100-101 Rev. A1

Panasonic ideas for life



CONTACT

Dipl.-Ing.

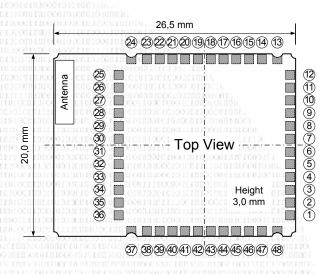
Heino Kähler

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DIMENSIONS



Pin no.	Pin name
1	VBAT
2	REG_out
3	Reset
4	OSC32A
5	OSC32B
6 to 12	GPIO 0 to 6
13,24	GND
14 to 23	GPIO 7 to 16
25	SIF_CLK
26	SIF_MISO

Pin name
SIF_MOSI
SIF_LOADB
n.c.
GND
RF
GND
VC1
n.c.
Reg_EN
Reg_IN

Note:

Access to the programming interface pins 25, 26, 27, 28, 1, and 3 has to be provided on the application board.

TECHNICAL CHARACTERISTICS

Parameter	Value	Condition / Note
Receiver Sensitivity	-98 dBm typ.	for 1% packet error rate
Output Power	3 dBm 5 dBm	nominal boost mode on
Power Supply	2.1 V to 3.6 V	3.0 V typ.
Error Vector Magnitude	15 (25) %	typical (maximum), as defined by IEEE802.15.4-2003
Maximum Data Rate	250kbps	over the air
Current Consumption total Rx current total Tx current total TX current DEEP SLEEP mode DEEP SLEEP mode	35.5 mA typ. 32.8 mA typ. 35.5 (41.5) mA 1.5µA 1.0µA	@ 0 dBm rf output power @ max Tx power, boost mode off (on) max, with 32.768KHz osc running max, with internal RC osc running
Operating Temperature Range	-40°C to +85°C	

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All parameters are valid for $V_{DD} = 3.0V$ and $T_{AB} = 25$ °C.

The data stated above is preliminary data.